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STATEMENT BY APPLICANT					Masaharu YAMAMOTO et		
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Sheet	1	of	1	Attorney Docket Number	062092		

U.S. PATENT DOCUMENTS						
Examiner Initials*	Cite No. ¹	Document Number		Publication Date		
		Number	Kind Code ² (if known)	MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	
	1	US 2004/0023487	Al	2/5/2004	Shiomi et al.	
		US				
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FOREIGN PATENT DOCUMENTS							
•	Cite	Fo	Foreign Patent Document			Name of Patentee or	
	No.	Country Code ³	Number ⁴	Kind Code ⁵ (if known)	Publication Date MM-DD-YYYY	Applicant of Cited Document	Translation ⁶
·	2	JP	2000-164746		6/16/2000	Sumitomo Special Metals Co Ltd	Abstract
	3	JP	11-354699		12/24/1999	Furukawa Electric Co Ltd: The	Abstract
	4	JP	2003-209197		7/25/2003	Sumitomo Special Metals Co Ltd	Abstract
	5	PCT	WO02/078085	A1	3/22/2002	Sumitomo Special Metals Co., Ltd. et al.	Abstract
	6	JP	2000-106408		4/11/2000	Kyocera Corp et al.	Abstract
	7	JP	6-151618		5/31/1994	Kyocera Corp	Abstract
		<u> </u>			***-		
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Examiner Initials*	Cite No.1	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.			
	8	T. YAMAMOTO et al., "Evaluation of Reactivity between Sn-Ag Solder and Au/Ni-Co Plating to", 10 th Symposium on "Microjoining and Assembly Technology in Electronics, Feb. 5-6, 2004 pp. 117-122			
	9	International Search Report of International Application PCT/JP2005/017599 mailed November 15, 2005			

Examiner Signature	Date Considered	

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